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## PRODUCT NUMBER

## NOTES:

I. DIMENSIONS AND TOLERANCES ARE IN ACCORDANCE WITH ASME YI4.5M, 1994 UNLESS OTHERWISE SPECIFIED.

## CONNECTOR NOTES:

HOUSING MATERIAL: UL 94 V-0 GLASS FILLED

HIGH-TEMP THERMOPLASTIC

POWER CONTACT MATERIAL: COPPER ALLOY SIGNAL PIN MATERIAL: COPPER ALLOY

3. PLATING:

SIGNAL PINS: 30u"/0.76um Au OVER 50u"/1.27um Ni POWER CONTACTS: 50u"/I.27um Ni UNDER ALL

WITH 30u"/0.76um Au ON CONTACT AREA

AND SnPb ON PCB INTERFACE

MANUFACTURER'S NAME, P/N, AND DATE CODE TO APPEAR ON THIS SURFACE.

5. PRODUCT SPECIFICATION GS-12-149. APPLICATION SPECIFICATION BUS-20-067.

6. PACKAGED IN TRAYS.

PCB NOTES:

7. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE.

MOUNTING HOLES, WHERE APPLICABLE, ARE UNPLATED.

 $\emptyset$ .0453 $\pm$ .0010 [1.151 $\pm$ 0.025] DRILLED HOLES PLATED WITH .0003 [0.008] MIN SnPb OVER .001 [0.03] TO .003 [0.08] Cu PLATING TO ACHIEVE Ø.040±.003 [1.02±.07] HOLE.

"DIM XXX" TO BE DETERMINED BY THE CUSTOMER.

CONNECTOR KEEP-OUT ZONE.

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Printed: Aug 14, 2003

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PDM: Rev:A

STATUS: Released